



**COVALENT
METROLOGY**

Welcome

covalentmetrology.com



(Thin Film) Reflections on X-ray Reflectometry

Dr. Colleen Frazer
July 9, 2020 11am PDT

**COVALENT
ACADEMY**

EPISODE 12

RSVP at:
<https://bit.ly/covalent-12>



- **Founded 2016**
- **Testing, measurement & characterization Platform**
- **30 team members (11 PhDs)**
- **9,500 ft² lab in Sunnyvale, CA**
- **1-Stop-Shop Source for Answers**
 - 30 instruments in-house
 - 6 partnerships with instrument manufacturers
 - 11 partner labs
 - 6 corporate “tool shares”
- **More than 300 customers (80 % repeat)**

Covalent Technical Groups and Organization



hello@covalentmetrology.com

Electron & Scanning Probe Microscopy

*SEM / TEM, AFM,
EDS, EELS,
Nanoindentation,
Acoustic Microscopy*

Surface Analysis

*XPS, Auger,
TOF-SIMS,
d-SIMS*

Optical Microscopy & Spectroscopy

*Laser Confocal, White
Light, Chromatic
Aberration, Spectral
Ellipsometry, UV-Vis-Nir
Spectroscopy*

Materials / PC Board Failure Analysis

*Cross Sections,
Inspections, Dye &
Pry Testing*

X-Ray Characterization

*XRD / XRR,
XRF,
 μ CT*

Chemical Analysis

*ICPMS, GCMS,
FTIR, Raman
Spectroscopy, NMR*

Nanoparticle Analysis

*DLS, PSA,
Particle Zeta
Potential*

Bulk Properties Characterization

*DSC, TGA, DMA,
Rheometry, Tensile
Testing, Pencil Test,
Surface Zeta Potential*



Introducing Dr. Colleen Frazer

- Colleen supervises all X-ray Diffraction (XRD) and Reflectometry (XRR) operations and analysis: giving Covalent's customers access to the whole gamut of data available from this technique on their samples.
- Colleen obtained her PhD in Materials Science and Engineering from the University of Kentucky, concentrating on XRD residual stress measurements in highly textured materials.
- She has focused on XRD/XRR operation and advanced interpretation throughout her career, spanning Academic institutions, National Labs and private companies: ORNL, University of Kentucky, Penn State University, Sandia National Labs, Philips Lumileds and EAG.

XRR = X-Ray Reflectometry or X-ray Reflectivity

- Used to measure thin film properties:
 - Thickness
 - Density
 - Interfacial / surface roughness
- Nondestructive analysis
- Works well on crystalline, amorphous, and combination film stacks
- Sensitive to electron density perpendicular to surface

This webinar will cover:

- Indispensable sample alignment strategies
- Interpreting results without overinterpreting
- Working in the real world
- Troubleshooting with confidence



Wilhelm Röntgen

Discovered X-Rays (1895), received first Nobel Prize in Physics

Heinz Kiessig

Published paper noting X-Ray oscillations from smooth interfaces (1931), still referred to as “Kiessig fringes”



Lyman Parratt

Formalized XRR (1954), Group Leader in Manhattan Project, Head of Physics Department at Cornell University

 **Rigaku**

XRR

PRODUCTS INDUSTRY APPLICATIONS TECHNIQUES SUPPORT

In The Lab



SmartLab

Advanced state-of-the-art high-resolution XRD system powered by Guidance expert system software

In-Line Metrology



MFM310

Process XRR, XRF, and XRD metrology tool for blanket and patterned wafers; up to 300 mm wafers

- Ongoing partnership with Rigaku Corporation
- Latest-generation **SmartLab Multi-Purpose X-Ray Diffractometer** in our lab
- 9kW Rotating Anode X-Ray Source + Hypix-3000 Hybrid Pixel Array Detector in 0D mode
 - **very fast, accurate XRR measurements**
- **Rigaku SmartLab Studio II XRR** software
 - Analyze multi-layer, complex thin films stacks of various materials with minimal uncertainty
- In-line XRR metrology is also available through Rigaku Corporation: we will be happy to put you in touch with the representative if you would like to learn more

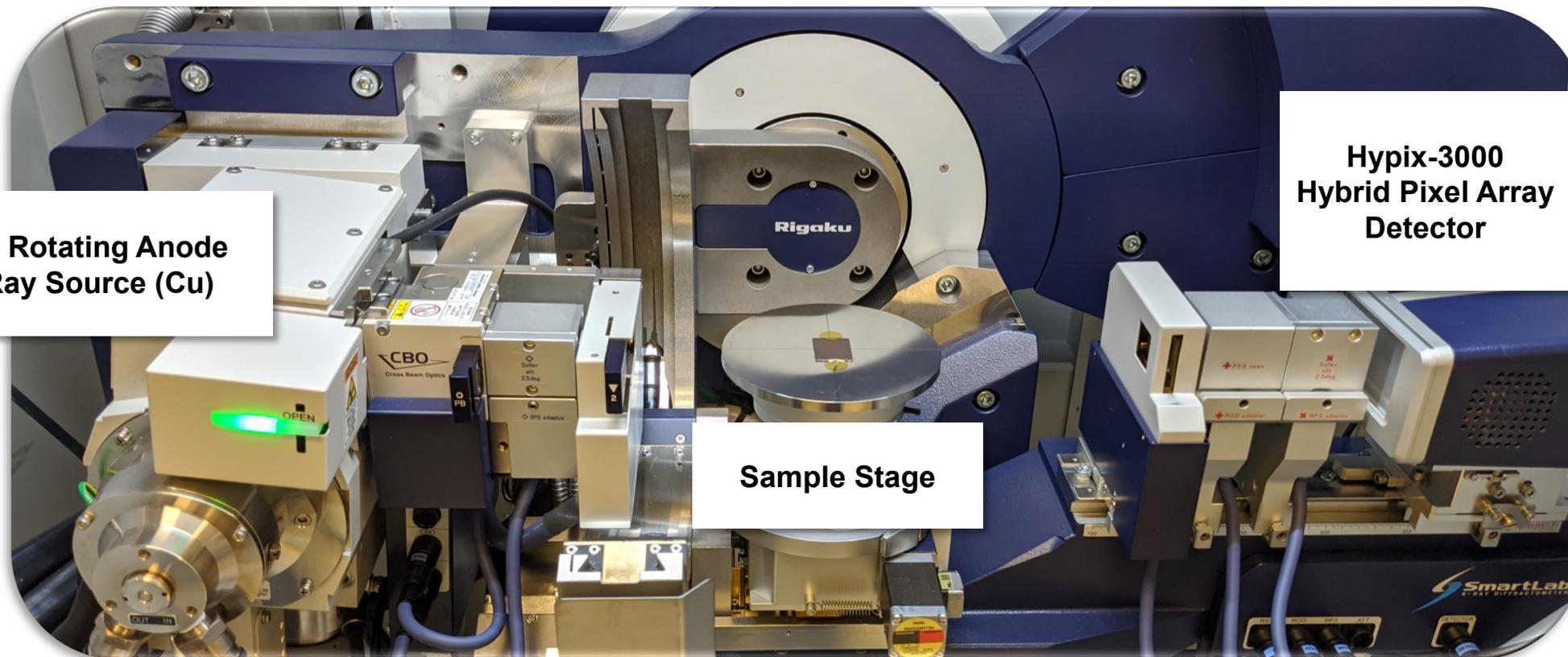
Covalent Metrology's Rigaku SmartLab 4-Circle Goniometer

9

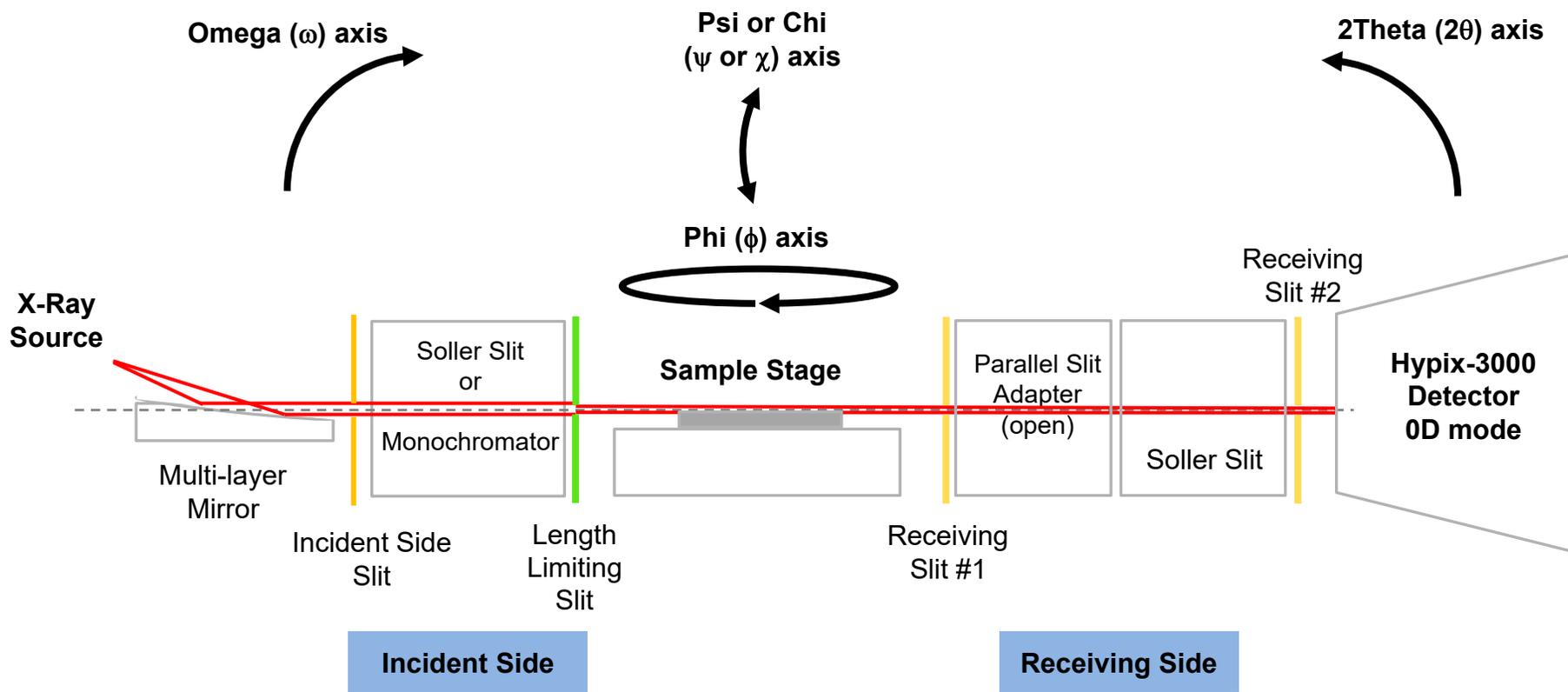
**9kW Rotating Anode
X-Ray Source (Cu)**

**Hypix-3000
Hybrid Pixel Array
Detector**

Sample Stage

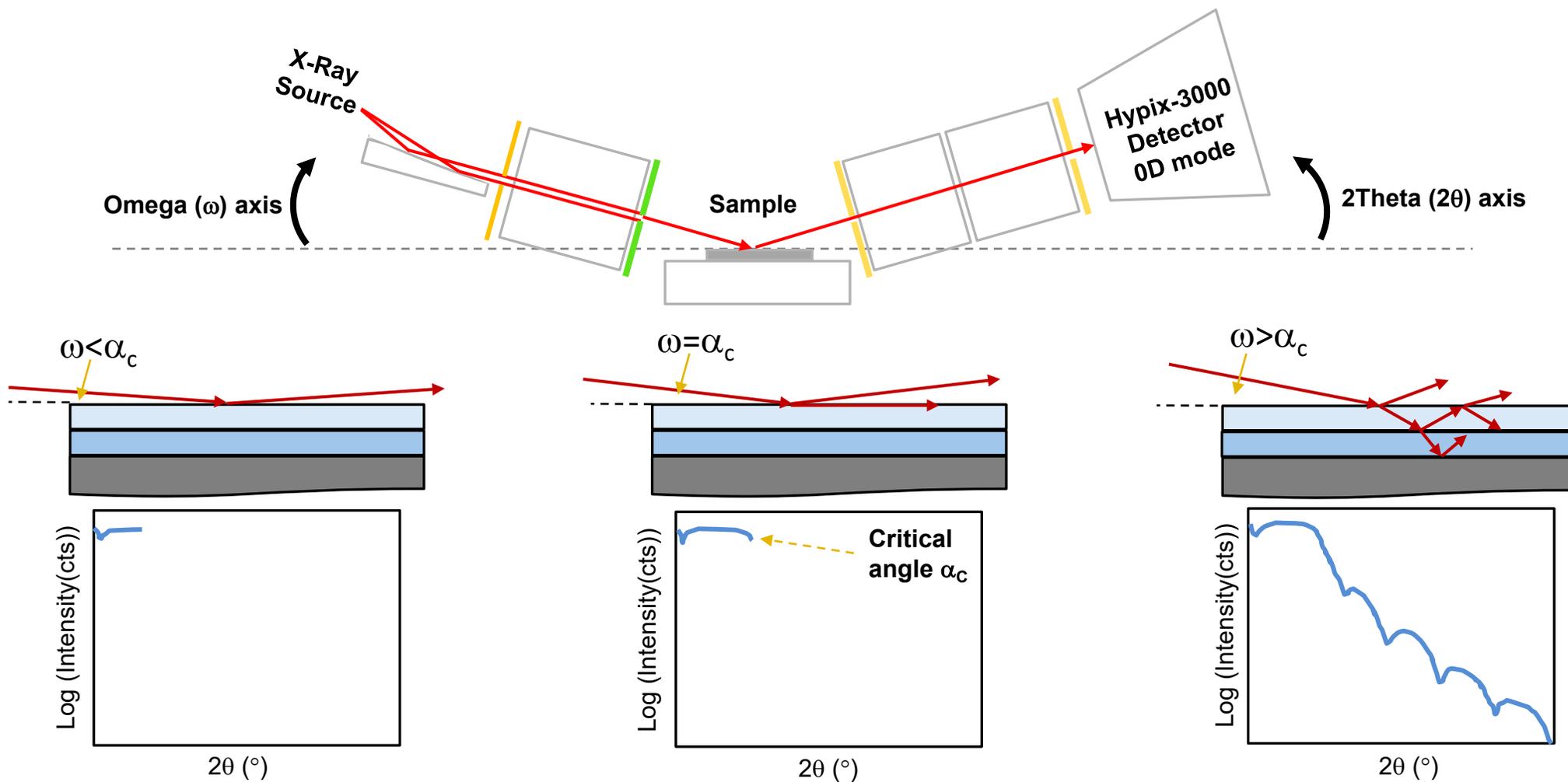


XRR scans are typically 2Theta-Omega ($2\theta-\omega$) scans

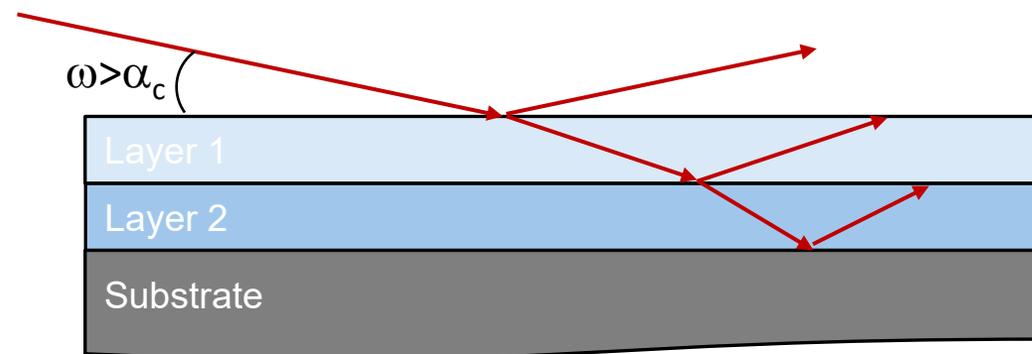
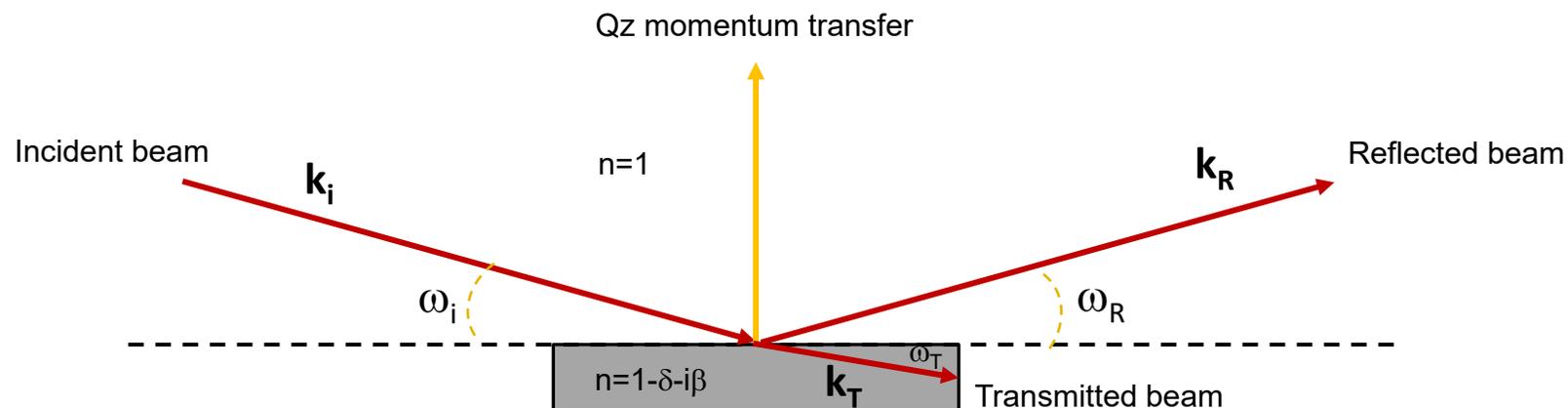


XRR Scans With Measurement Axes

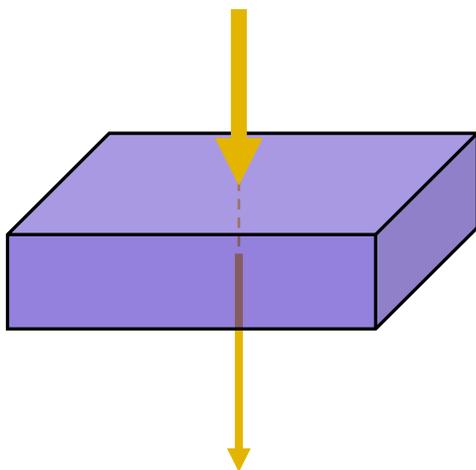
XRR scans are collected at very low incident and reflected angles, almost parallel to the sample surface (schematic angles exaggerated for clarity)



Specular reflectivity uses symmetric incident and reflected angles and represents a combination of Fresnel reflectivity and interference patterns



Bulk material, in transmission



$$I = I_0 \exp(-\mu L)$$

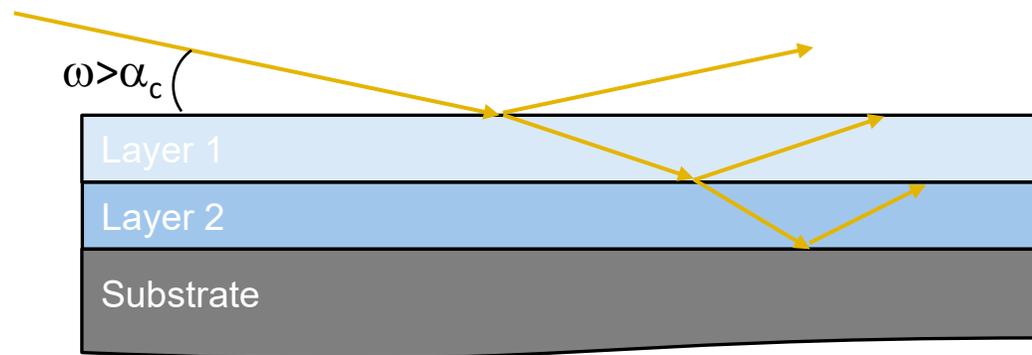
μ , linear absorption coefficient

L, distance

I/I_0 of ~10% is usually measurable

For Al, I/I_0 is ~76 μm

Multi-layer material, in reflection

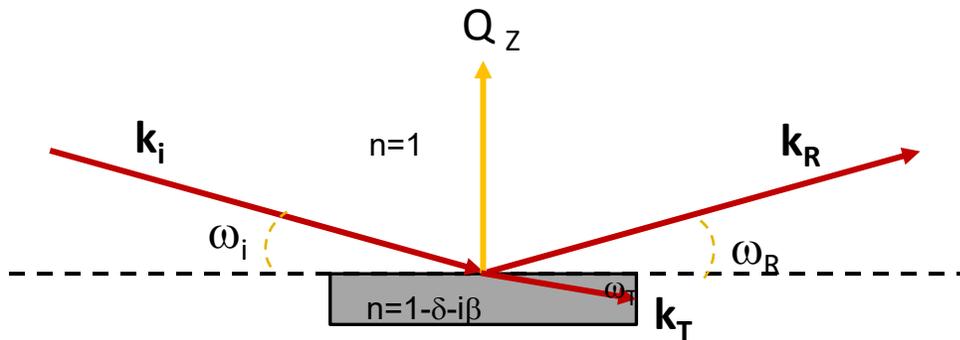


Above image shows the critical angle for total external reflection (α_c).

The beam path is affected by the incident angle, the physical properties of the layers, and interfaces between volumes of different electron densities (Snell's Law)

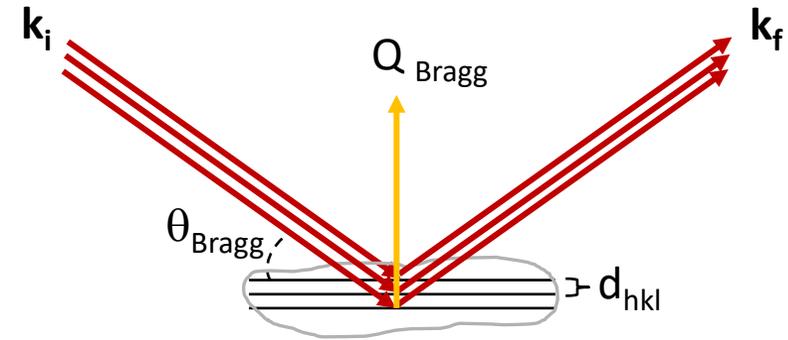
X-Ray Reflectivity is related to electron density differences at interfaces while X-Ray Diffraction is related to the interplanar spacings of crystalline materials

X-Ray Reflectivity



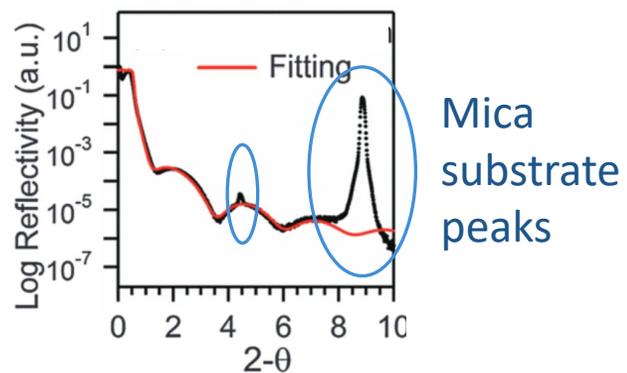
- Related to differences in electron density differences at interfaces
- Data collected at very low angles for the source and detector

X-Ray Diffraction



- Related to interplanar spacings of crystalline materials
- Data collected at low and high angles for the source and detector, and the axes can be uncoupled

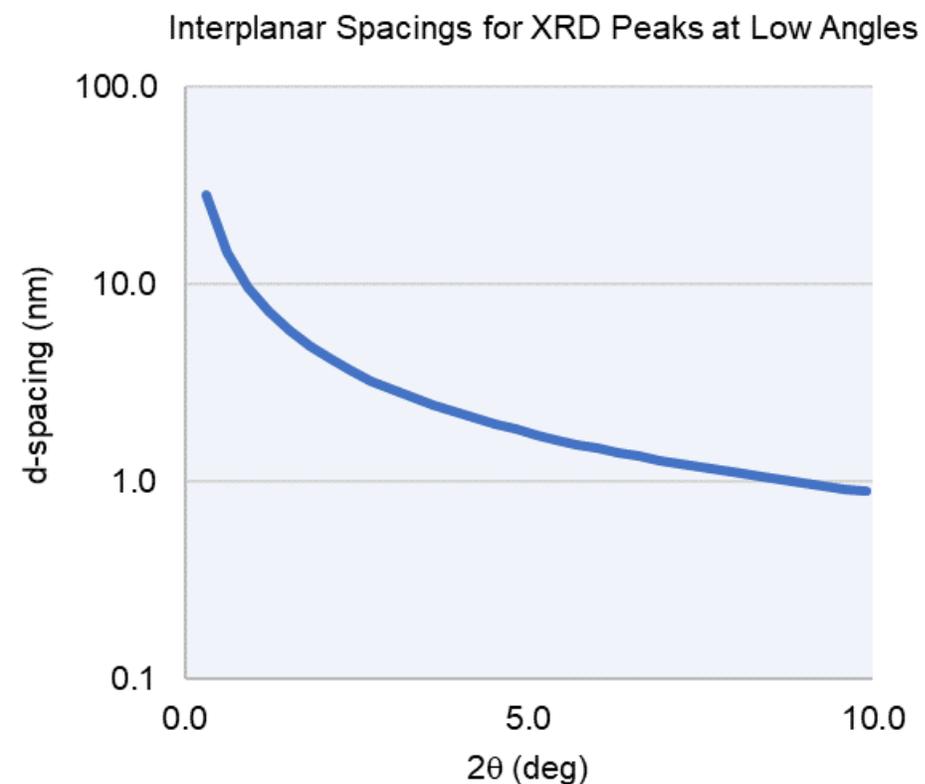
XRD peaks may appear in XRR scans due to large interplanar spacings



*Chem. Commun., 2016, 52, 2956

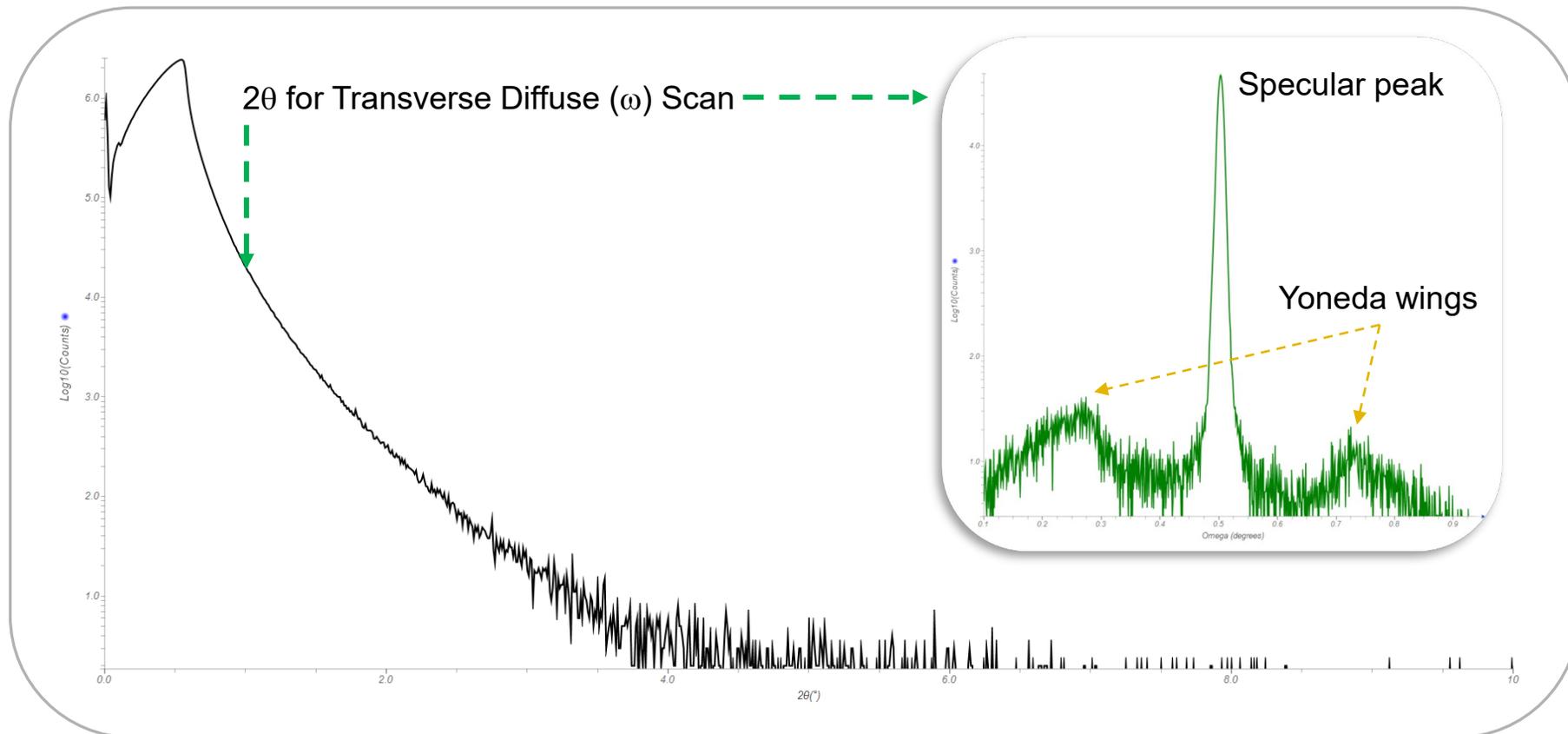
Bragg's Law: $n\lambda = 2d \sin \theta$

Mica peak at $\sim 9^\circ$ 2θ corresponds to interplanar spacing of ~ 1 nm for Cu-target X-Rays

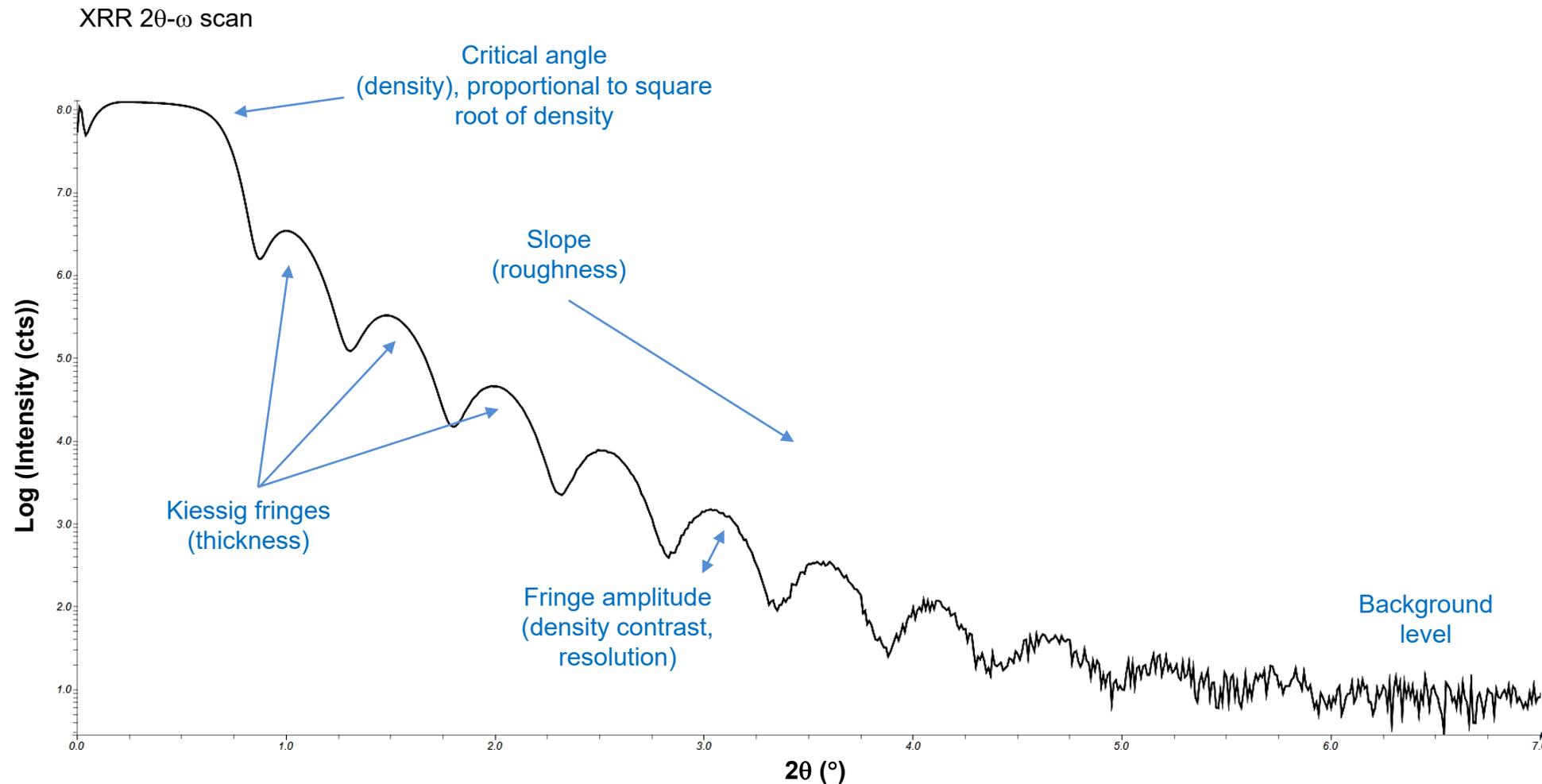


**Diffuse reflectivity = non-symmetric incident and reflected angles,
relates to lateral correlation**

Al₂O₃ Wafer Specular and Diffuse XRR Scans



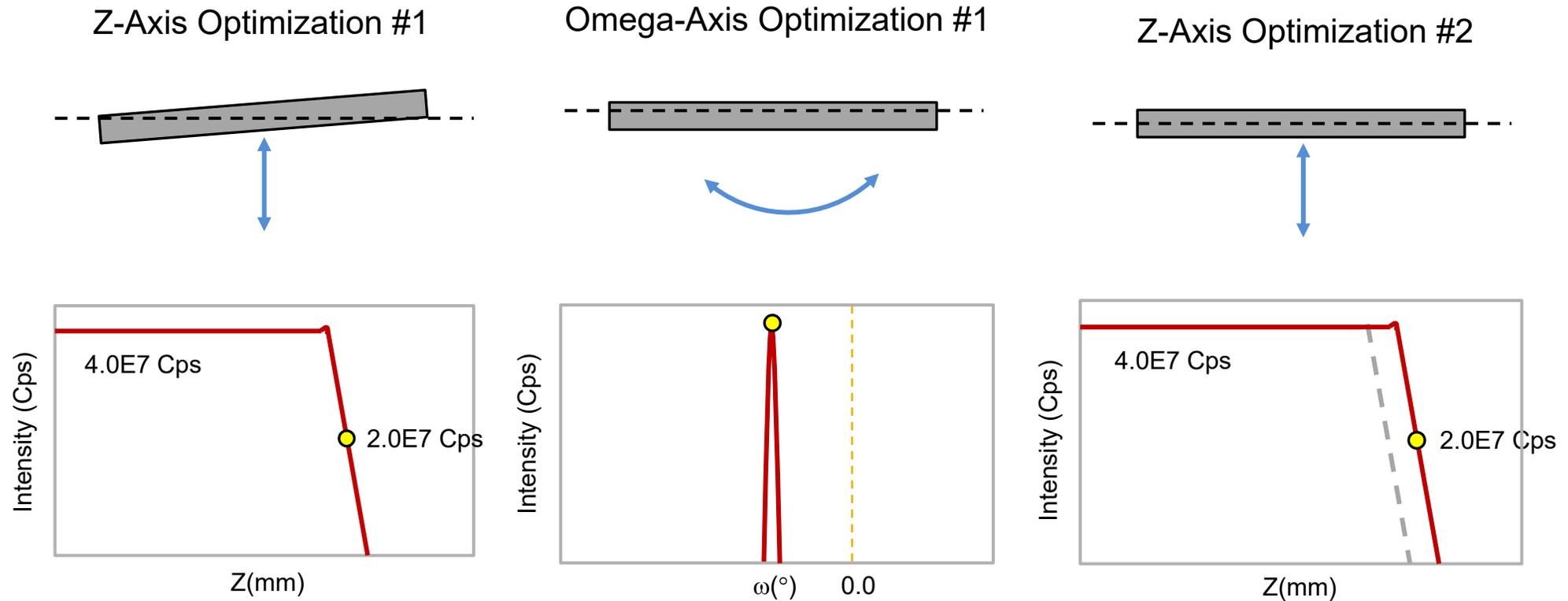
Features of a Specular XRR Pattern



The XRR pattern is shown courtesy of **Alluxa**, manufacturer of high-performance optical filters and precision thin-film coatings

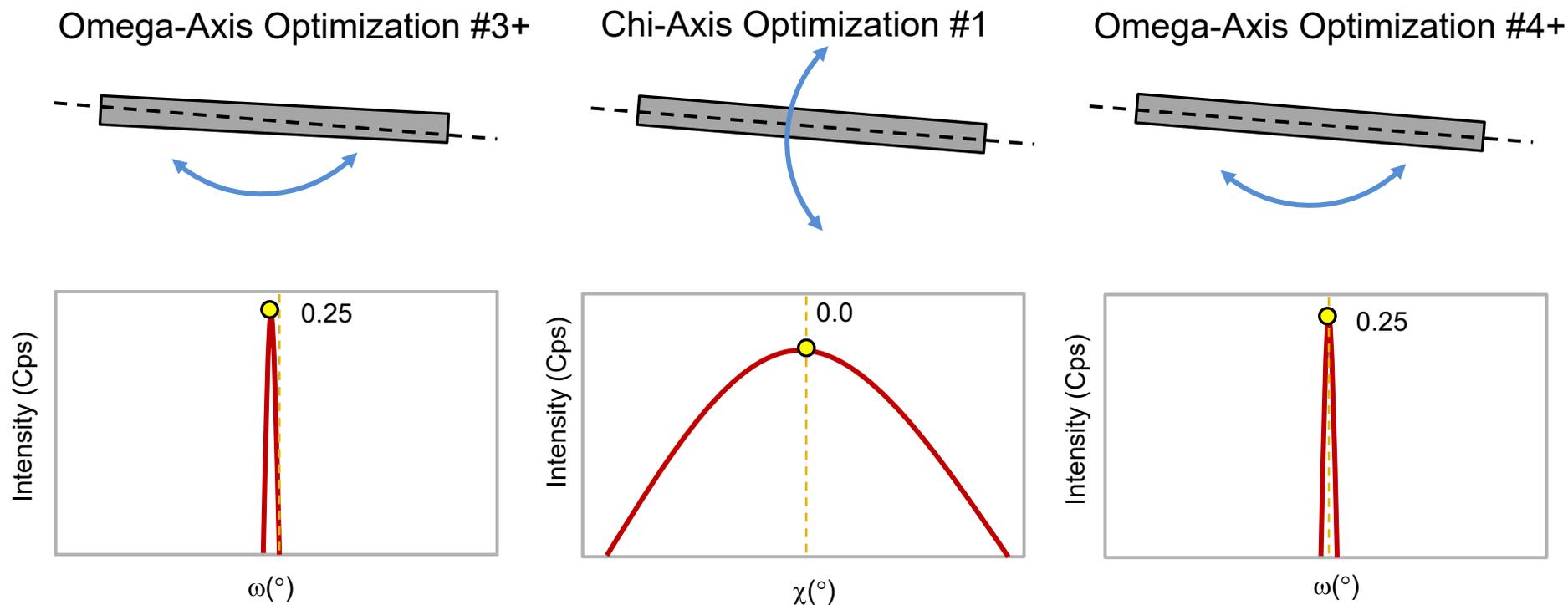
Direct X-Ray Beam

Steps are repeated until **NO** change is observed



Alignment on XRR Fringe

Steps are repeated until **NO** change is observed



Likelihood of XRR Success Due to Roughness

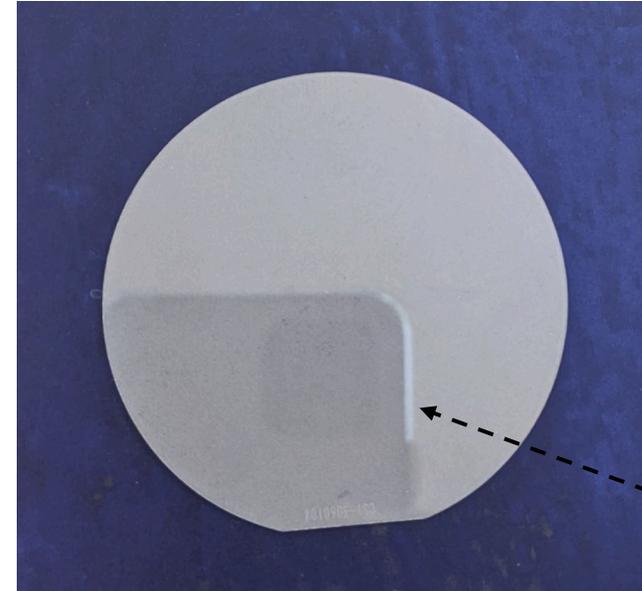
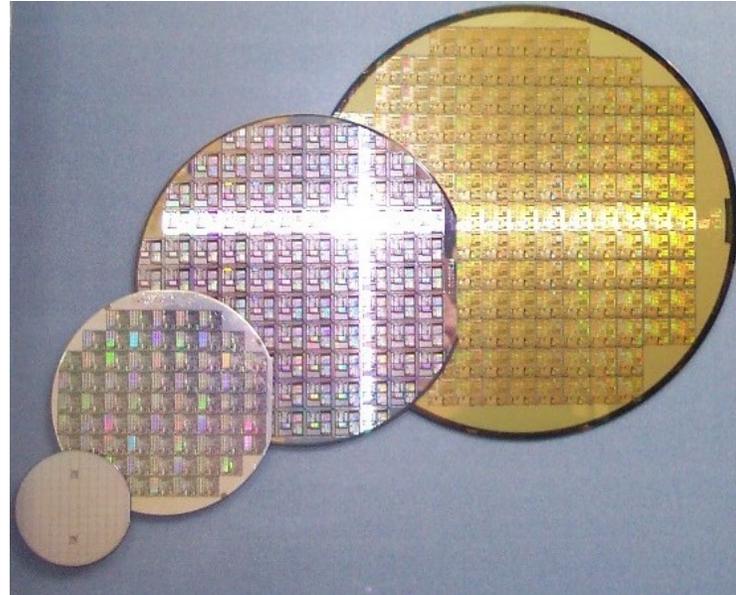


Image of
phone camera

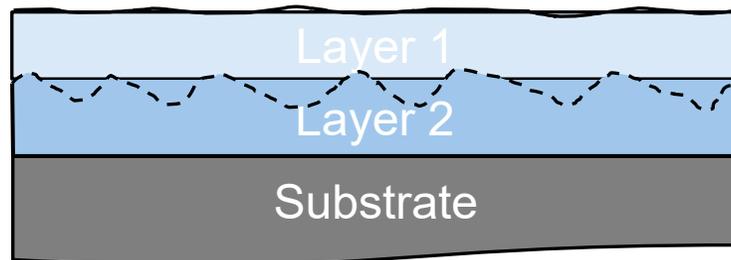
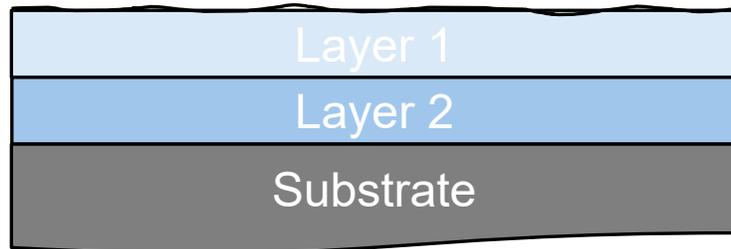
Very Unlikely

Very Likely

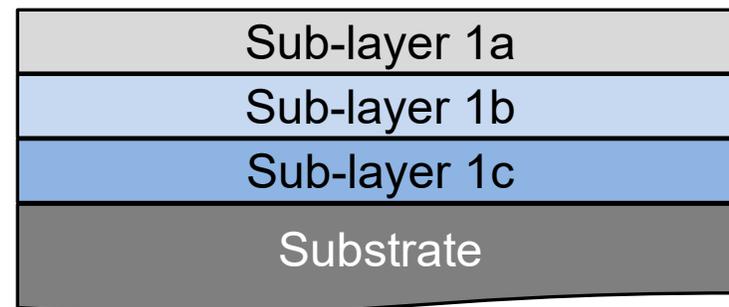
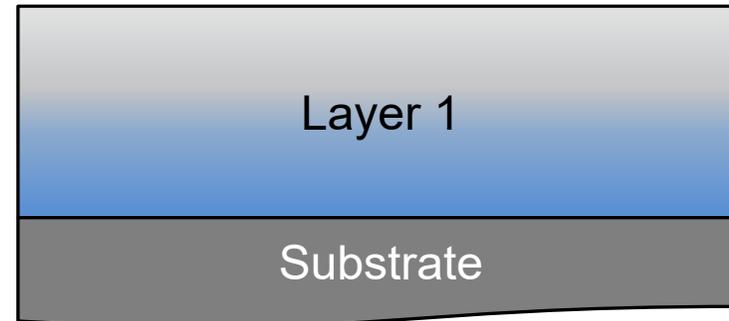
- Film thickness less than 1000nm
- Roughness less than 2nm
- Good lateral homogeneity

Vertical gradients may exist in the layers and often can be successfully modeled in more than one way

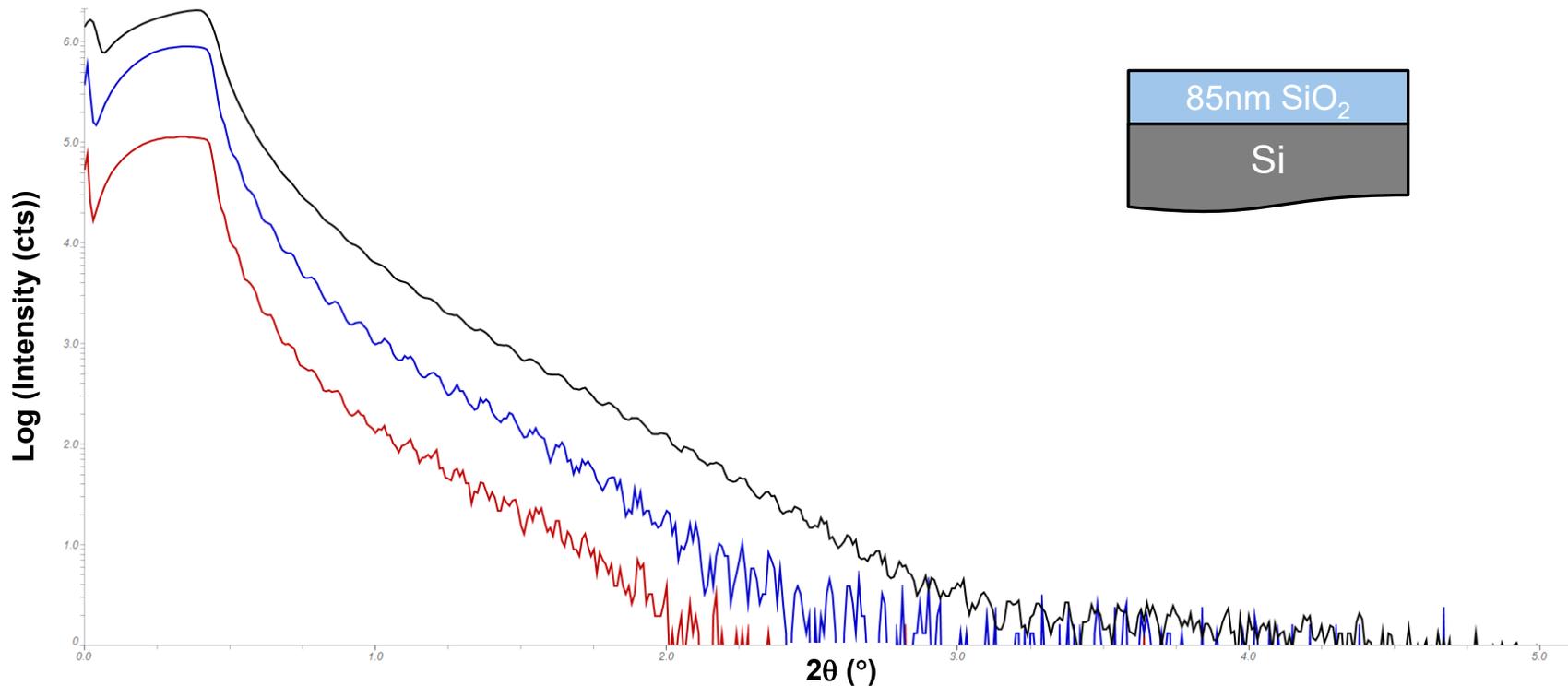
(Electron) Density gradients due to roughness



(Electron) Density gradients modeled in two ways

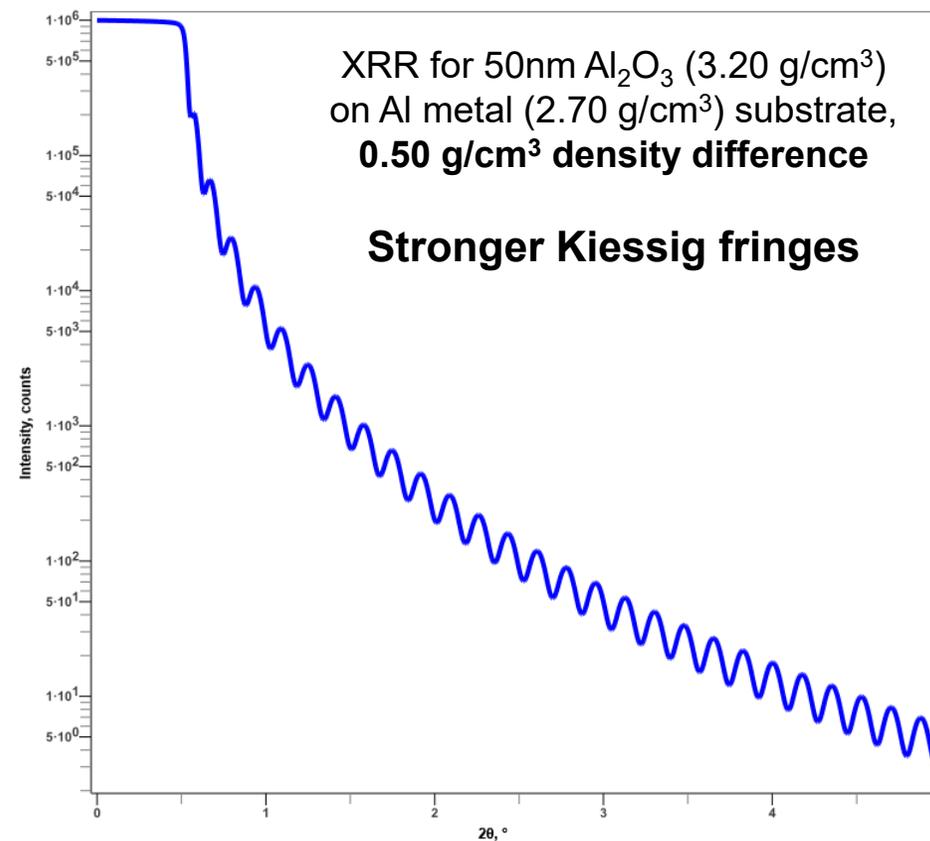
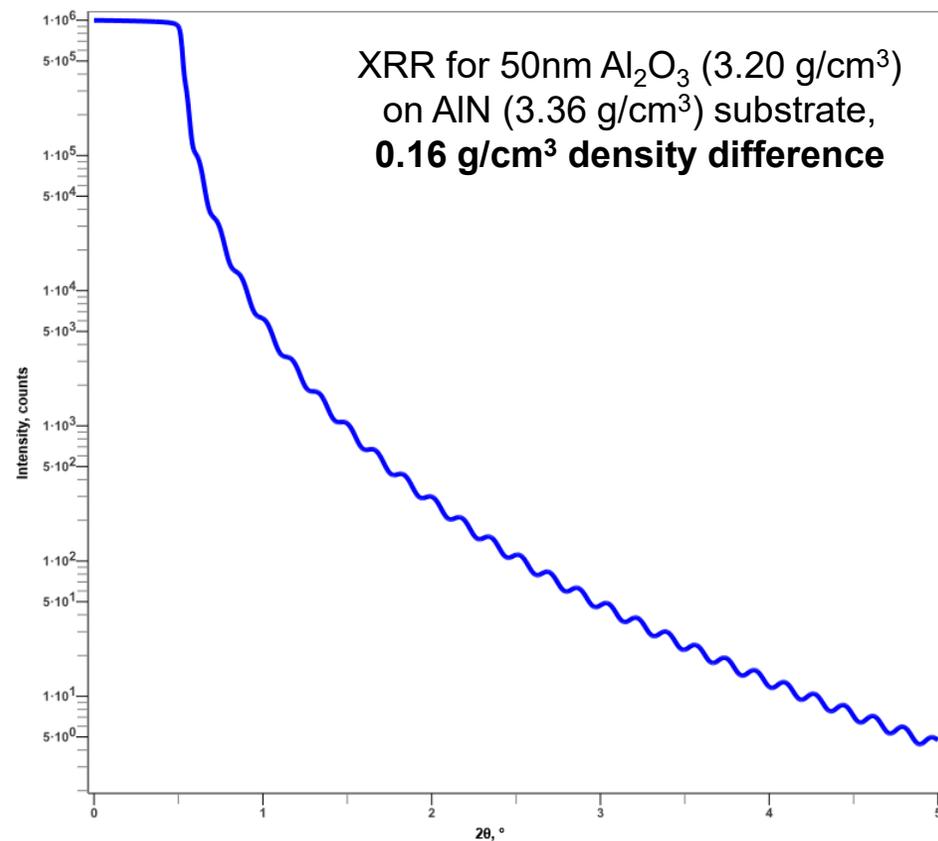


The use of narrower slits or a monochromator to increase resolution causes significant overall intensity decreases

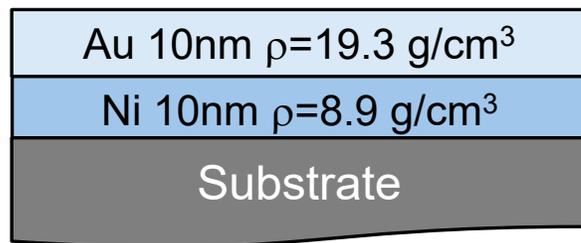


Scan Detail	Max Intensity (cps)	Relative Max Intensity (%)
Larger slits	5.40E+07	100%
Smaller slits	2.30E+07	43%
Ge(220)x2 Monochromator	2.90E+06	5%

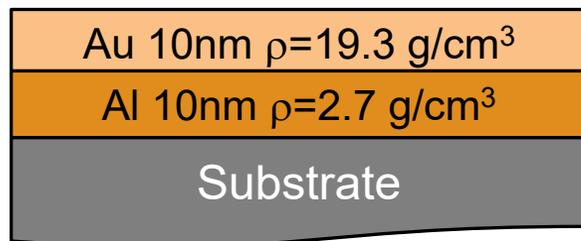
Greater density contrast results in stronger Kiessig fringes



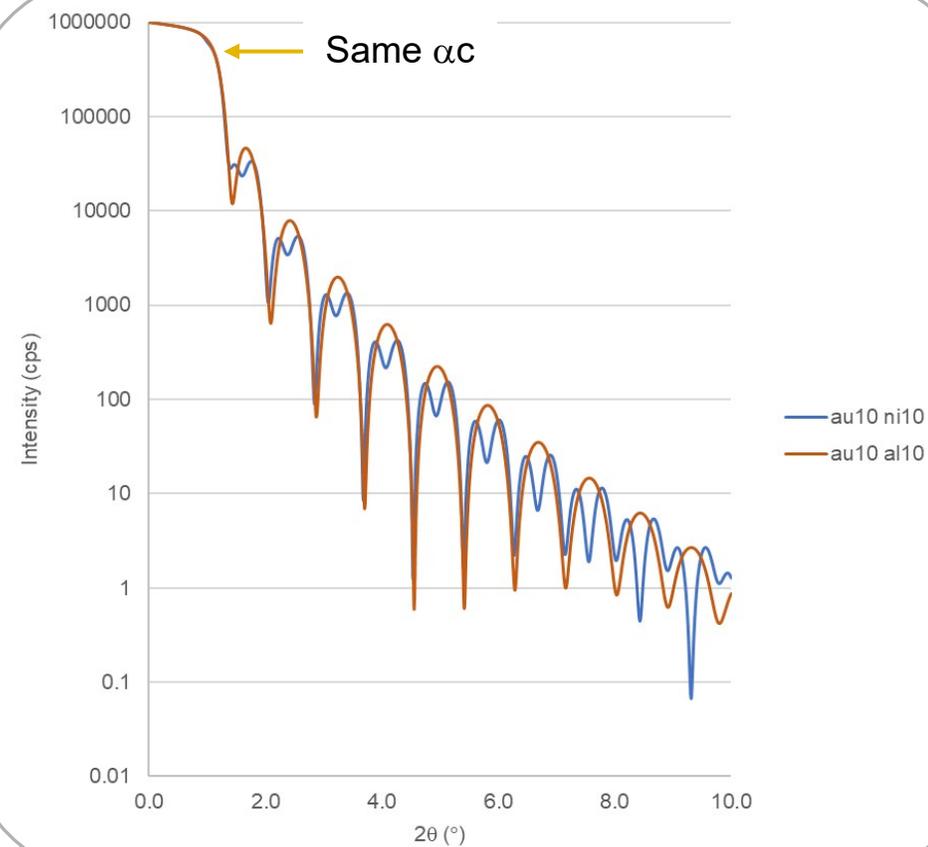
The critical angle is influenced more heavily by upper, dense layers than underlayers

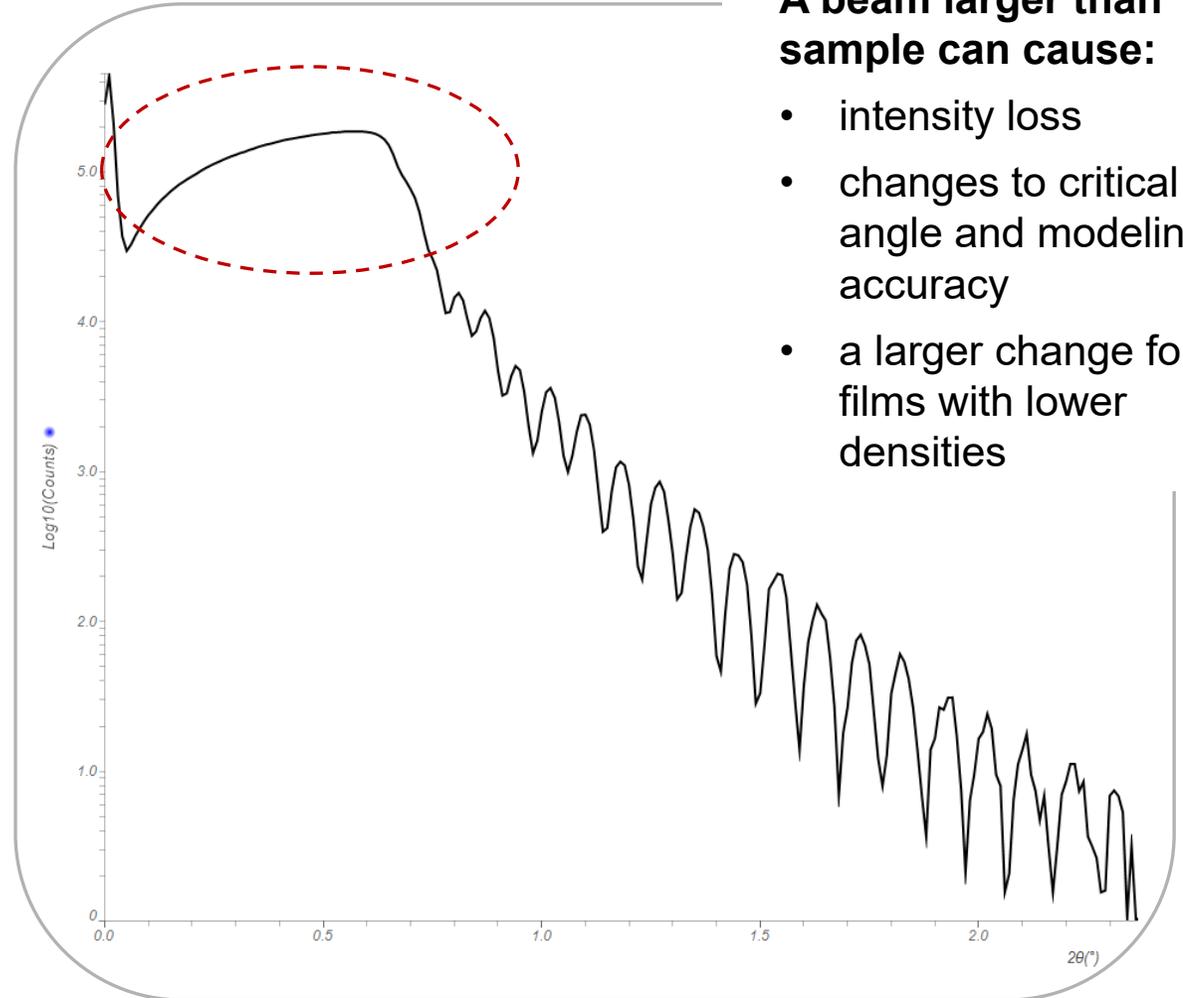
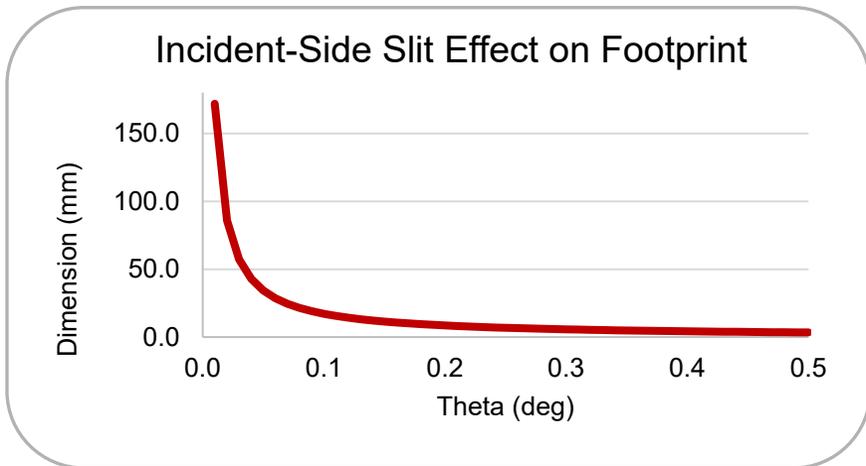
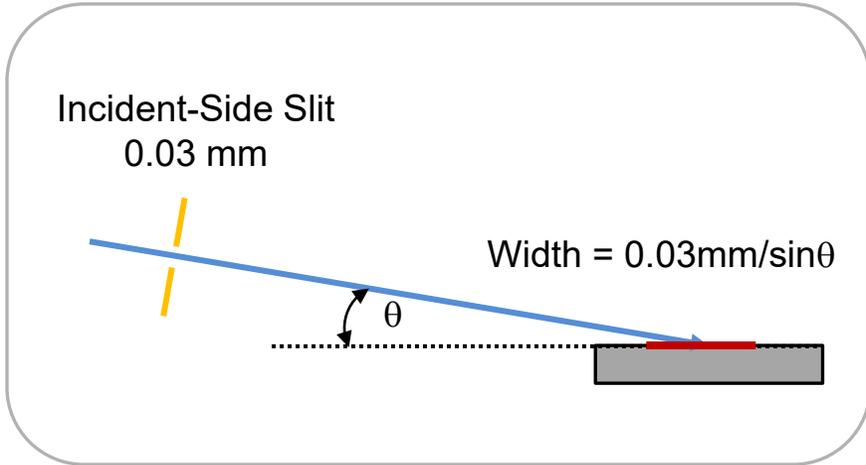


$\Delta \text{ Density} = 10.4 \text{ g/cm}^3$

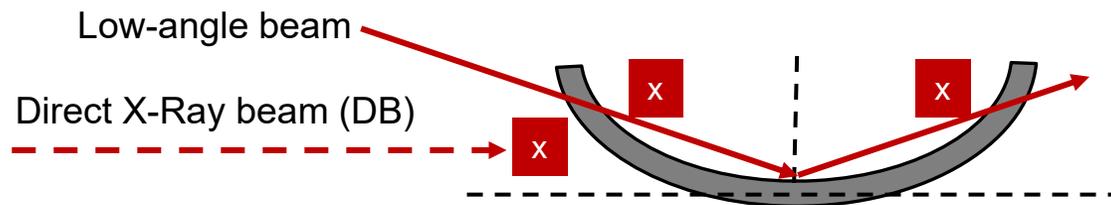


$\Delta \text{ Density} = 16.6 \text{ g/cm}^3$

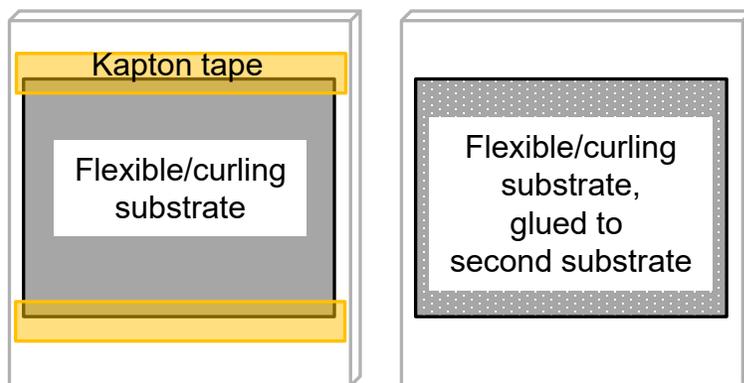




Flexible/curling substrate edges cause alignment error and can block low-angle measurements

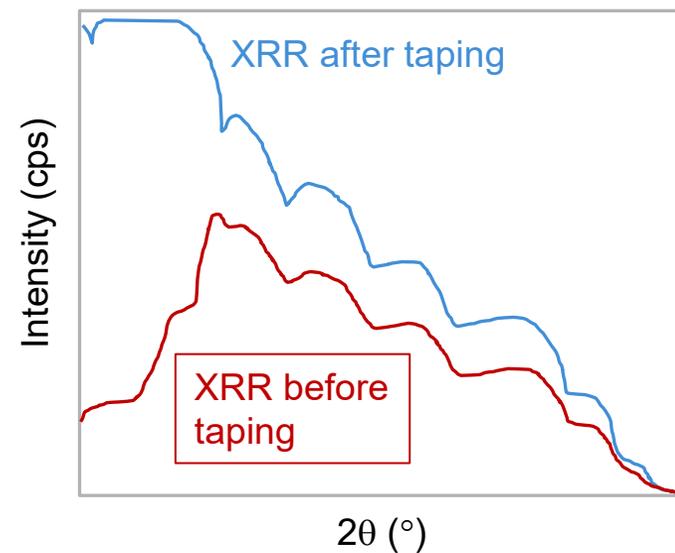


Simple Mounting Approaches

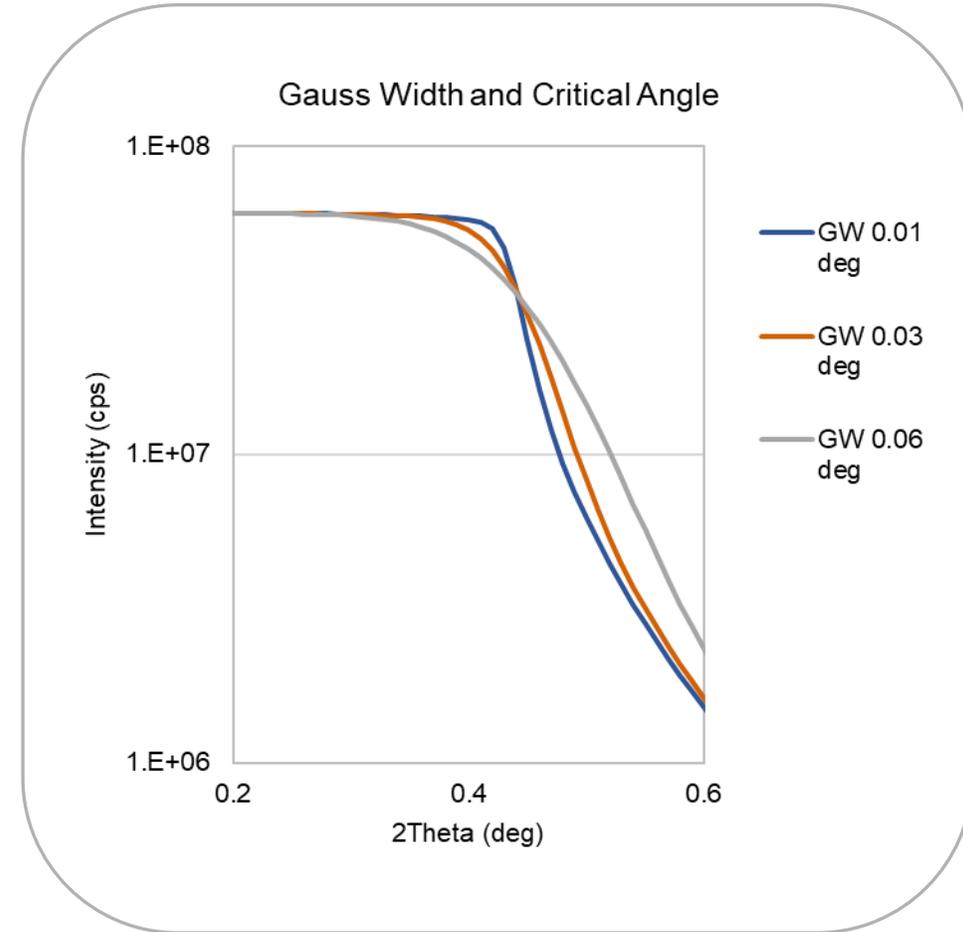
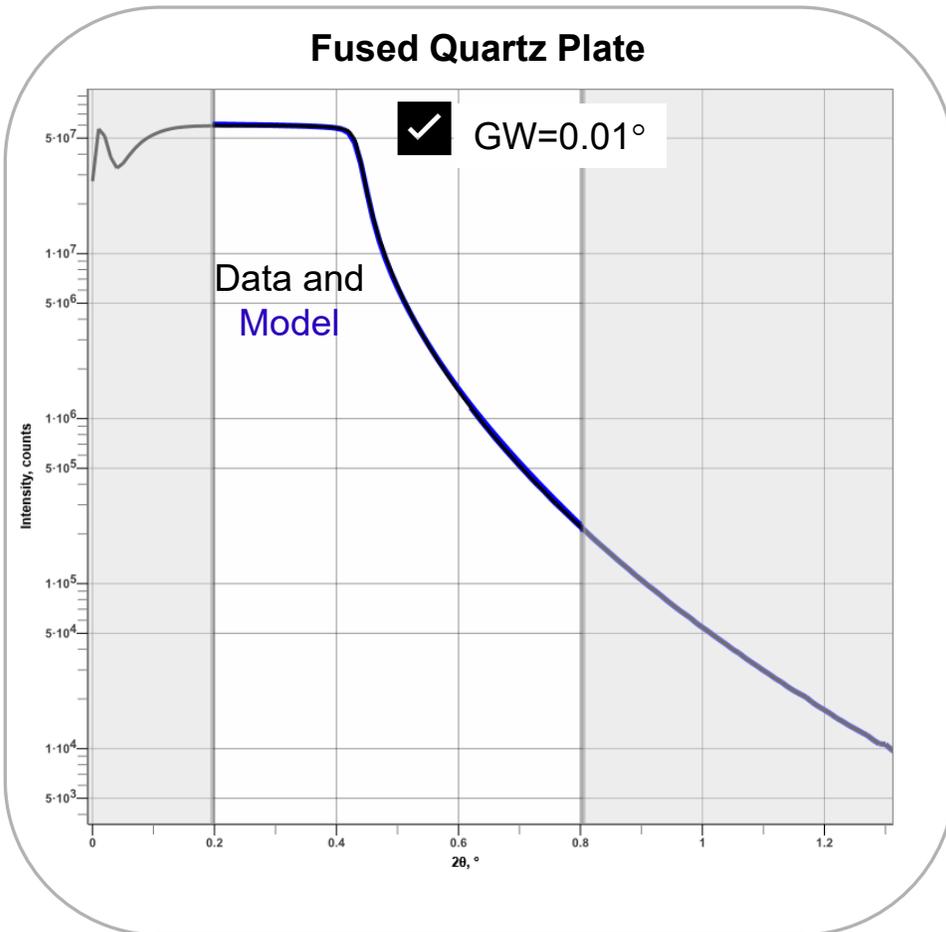


Glass slide or Si

Sample with Curling Substrate

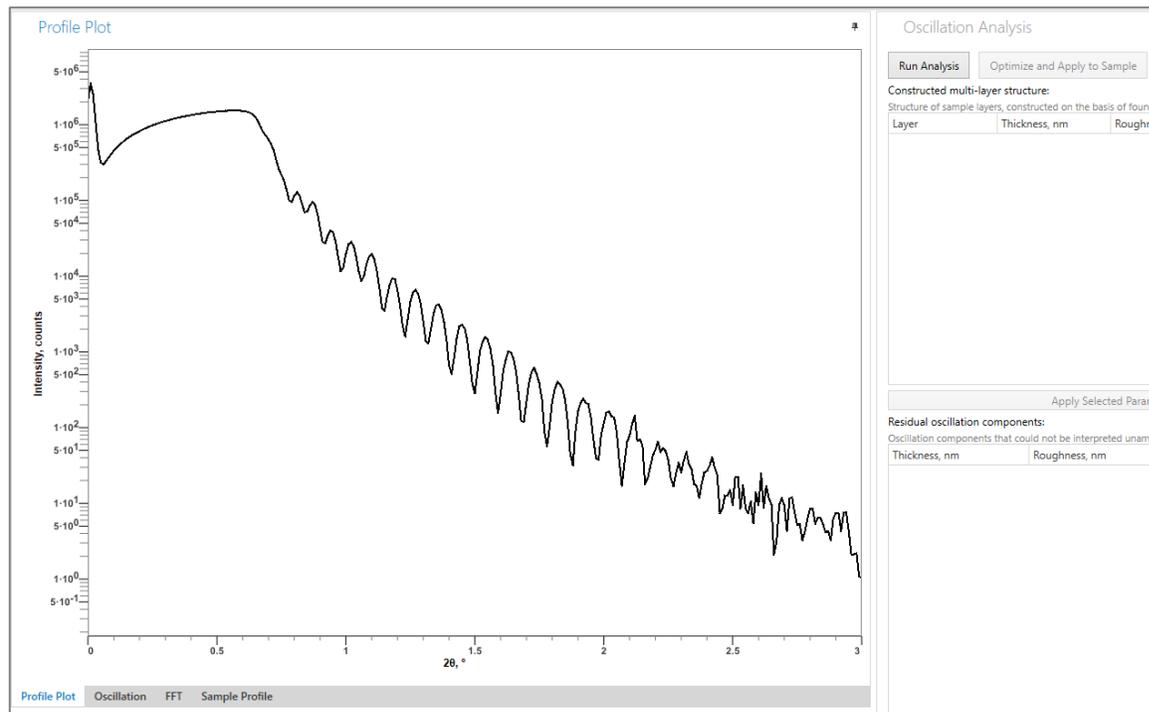


The Gaussian Width of your XRR system can be found from data from a clean, bare substrate



Rigaku SmartLab Studio II XRR Modeling Software

Robust program with oscillation analysis available



- **Model Input:**

- Scan file
- **Layer material (chemistry)**
- Approximate layer thicknesses (nm)
- Approximate layer roughnesses (nm)
- Gaussian Width (deg)

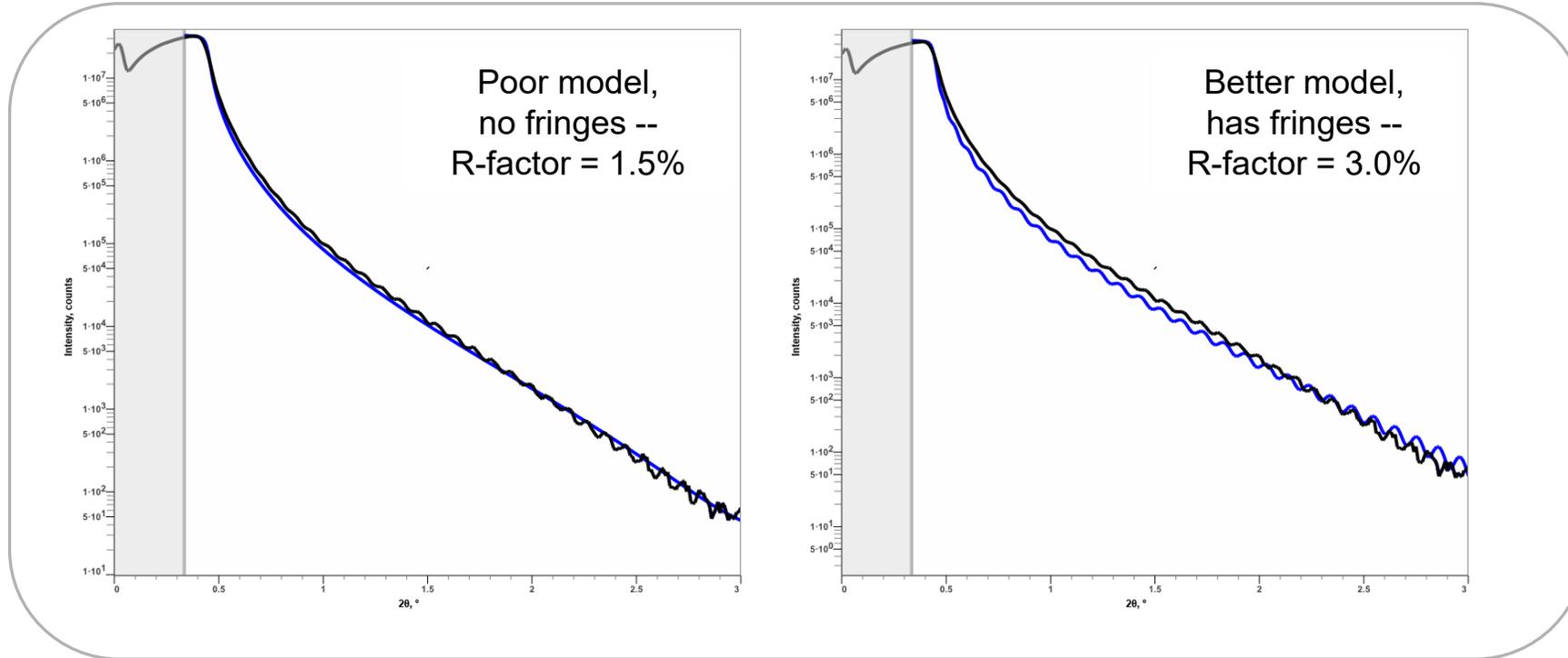
- Fit algorithms to choose from:

- **Genetic Algorithm**
- Nelder-Mead
- Quasi-Newton

- **Model Output:**

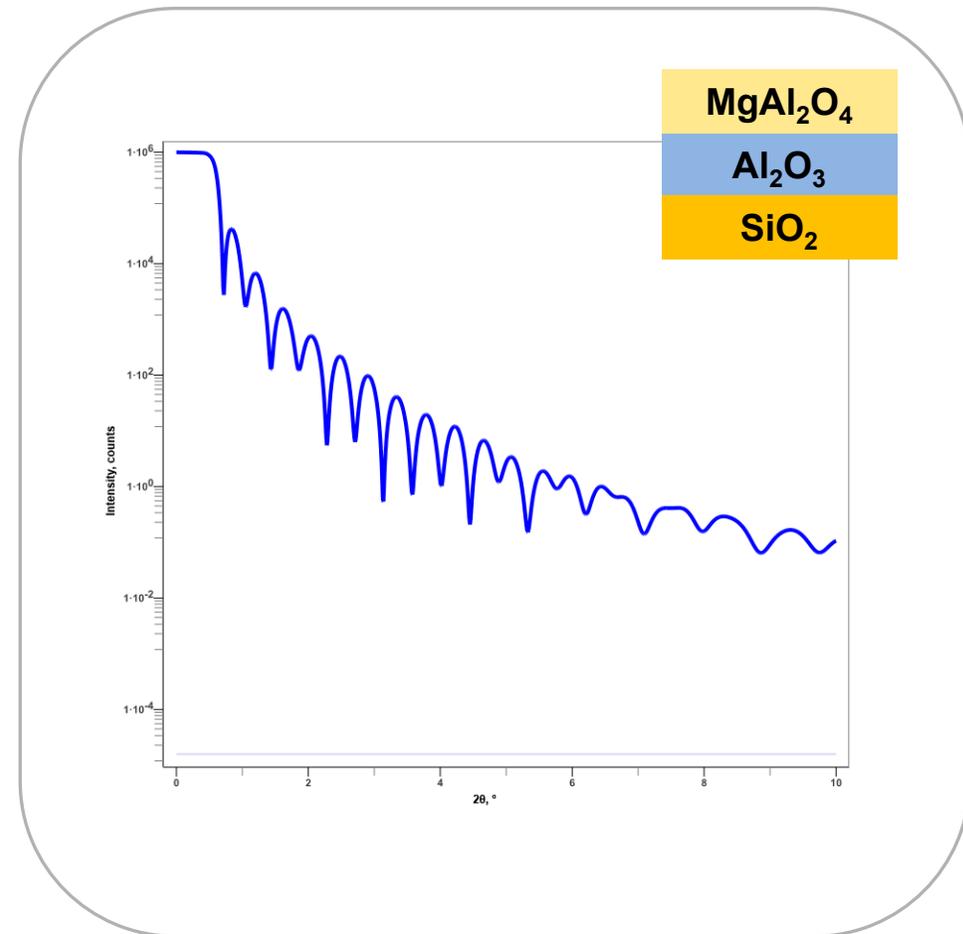
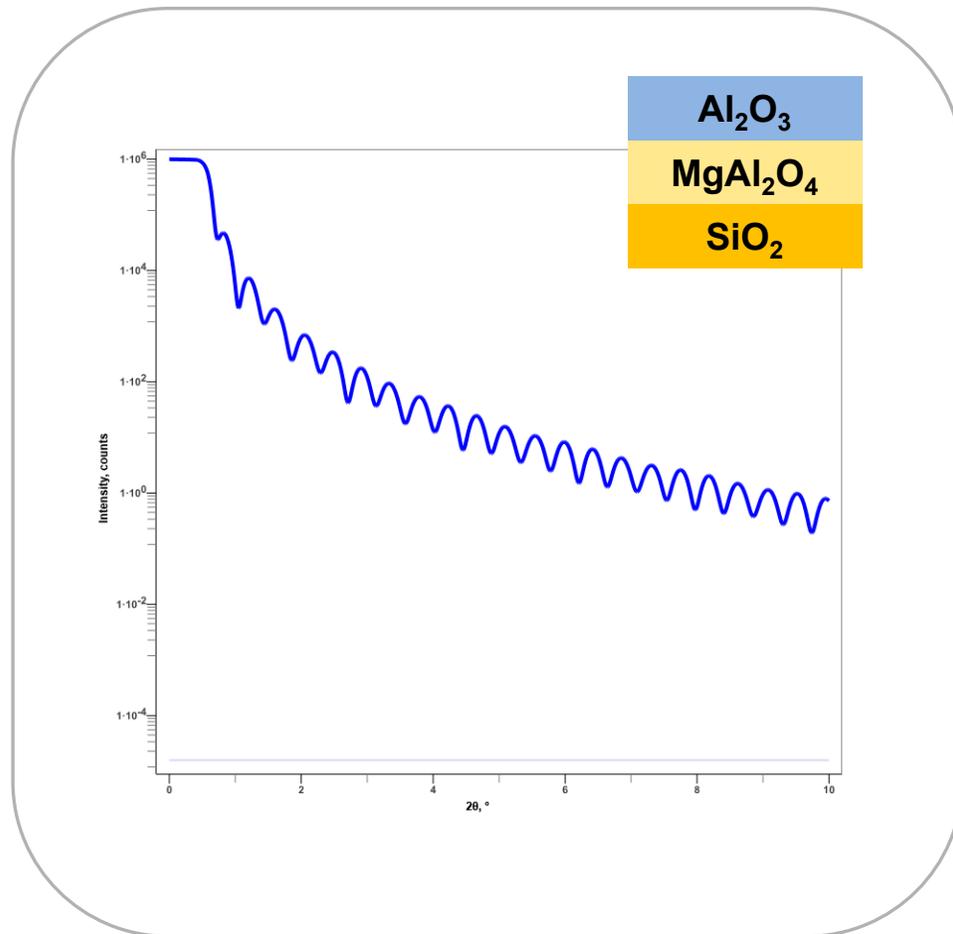
- **Refined layer thicknesses (nm)**
- **Refined layer densities (g/cm³)**
- **Refined layer roughnesses (nm)**
- **Error values for layer parameters**
- **Overlay plot of simulation and data**

The quality of the model fit cannot be assessed purely mathematically

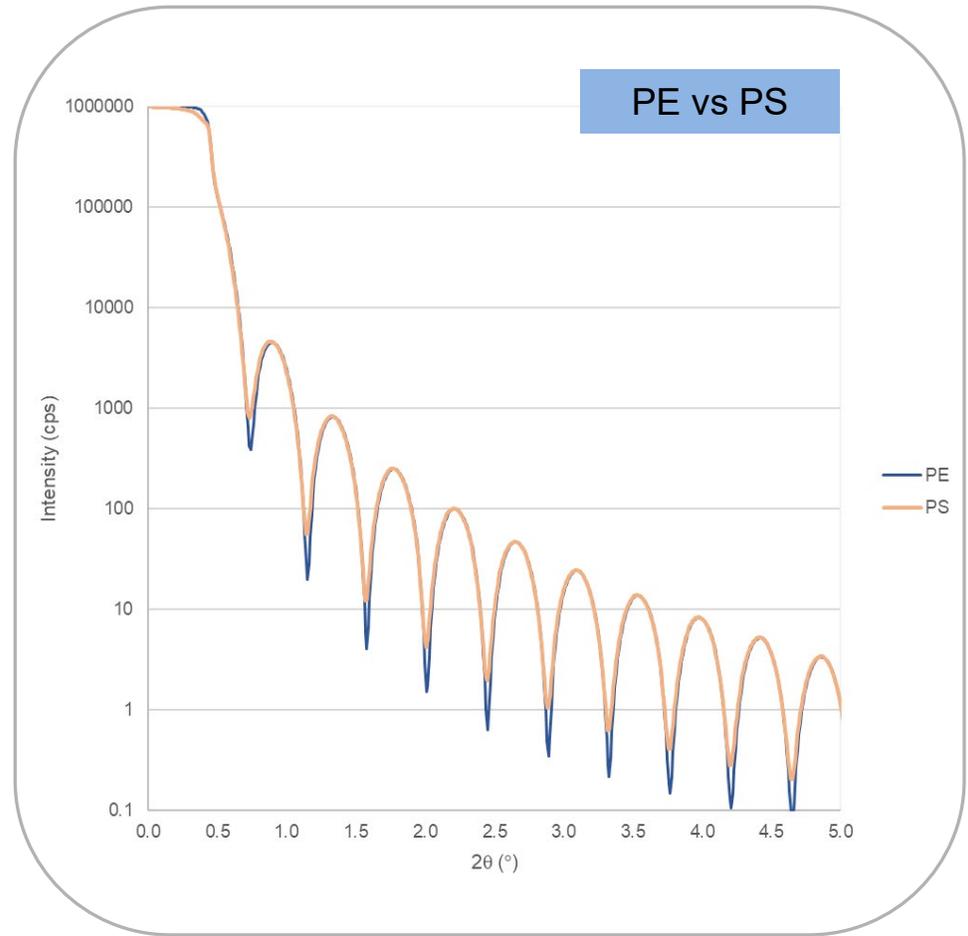
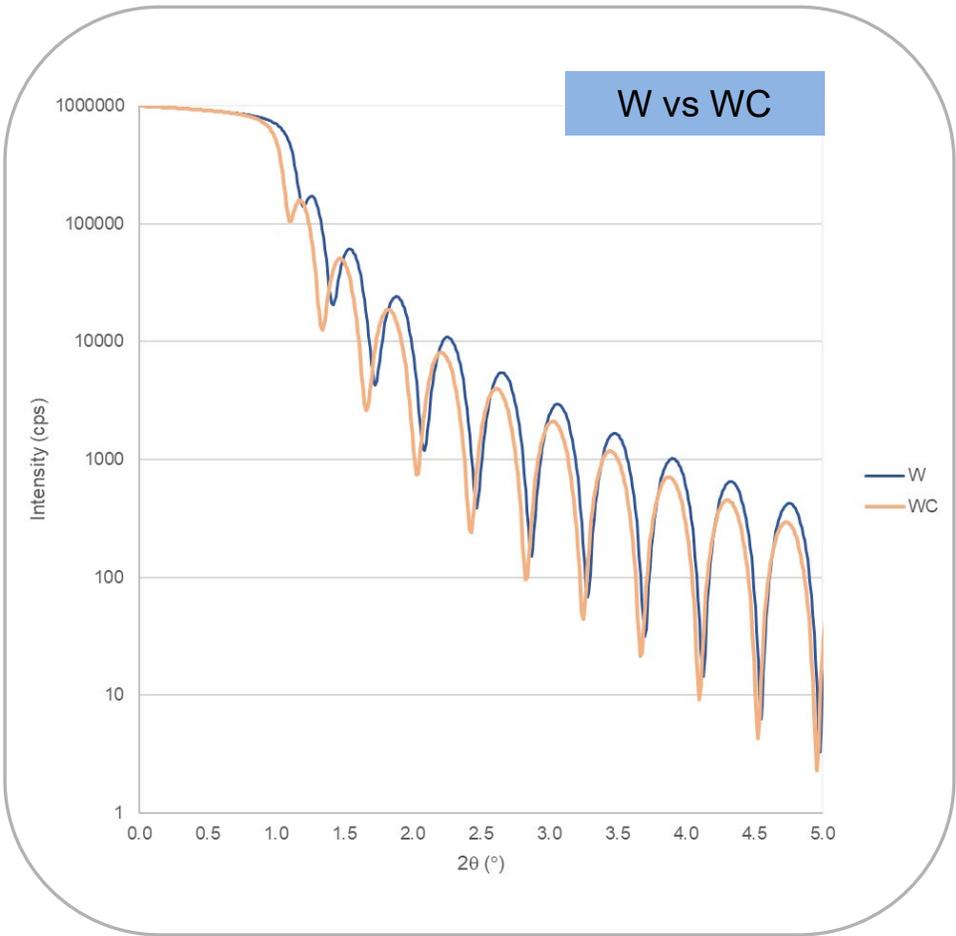


- Fitting error estimates for thicknesses, densities, and roughnesses are given by the Studio II software and are usually ± 0.01 or better
- NIST and NMIJ are working on a prototype certified XRR wafer for absolute error assessment as wafer stability and certification error ranges are issues to be solved

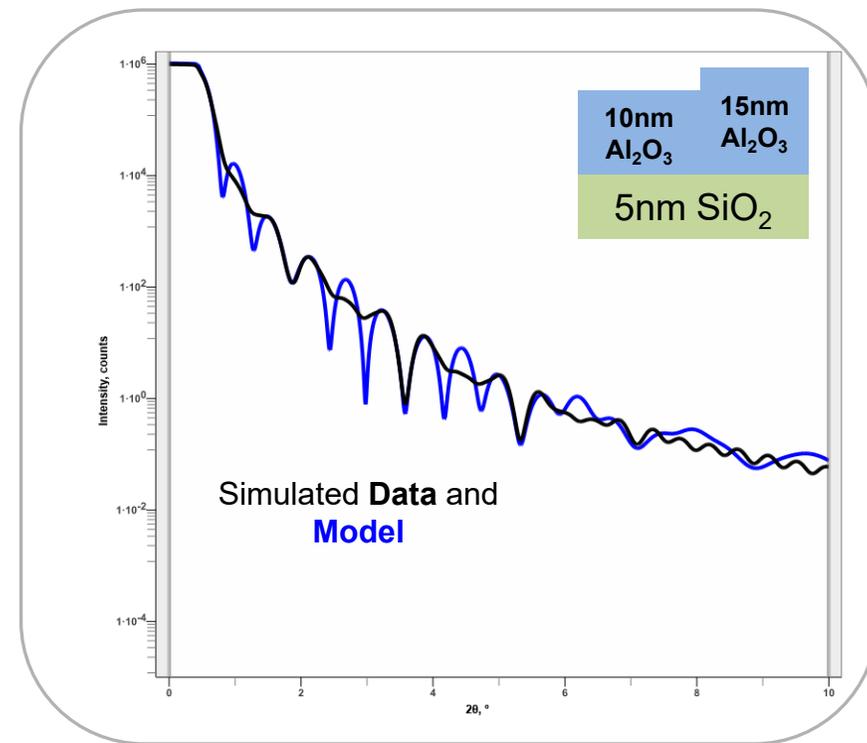
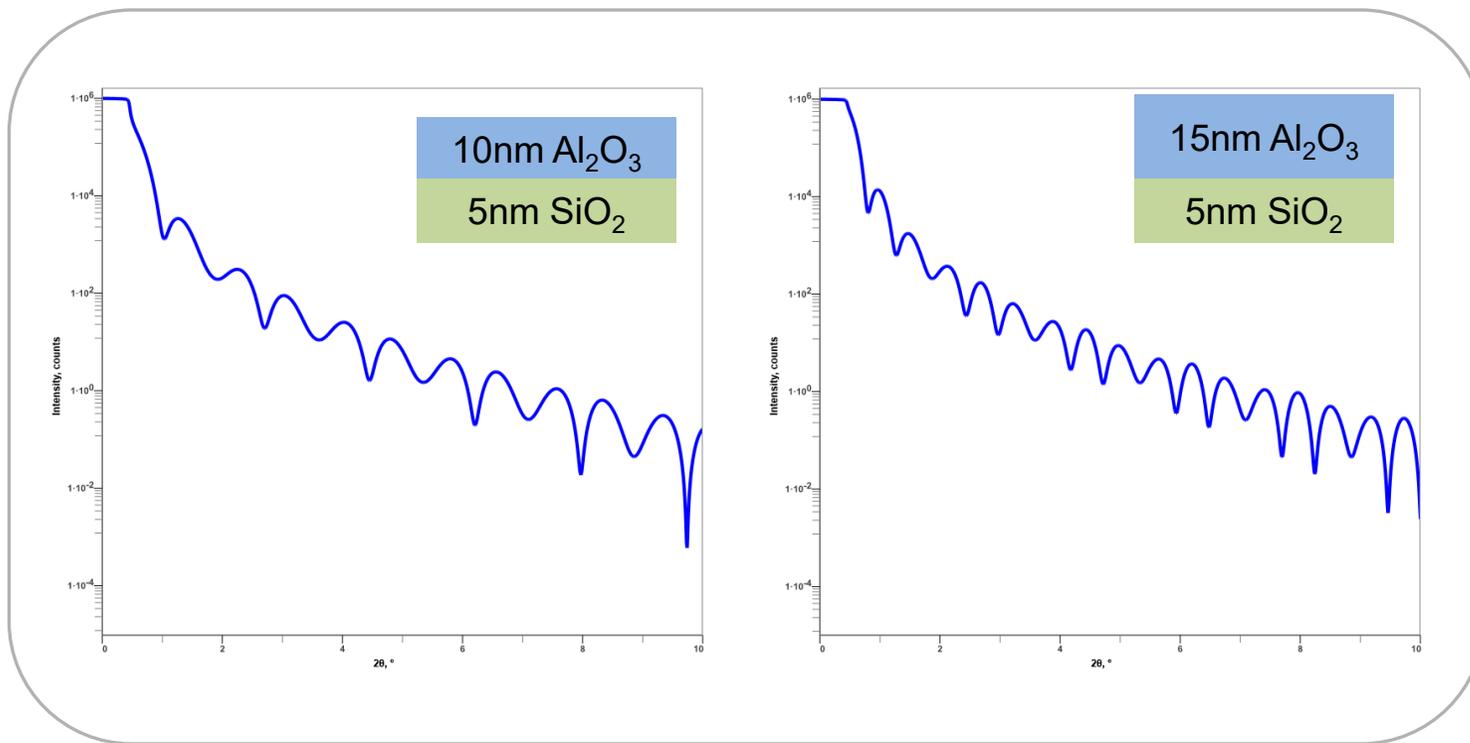
Density contrast and absorption effects change the XRR pattern when layer order is altered



The impact of inaccurate layer chemistry depends on the materials involved

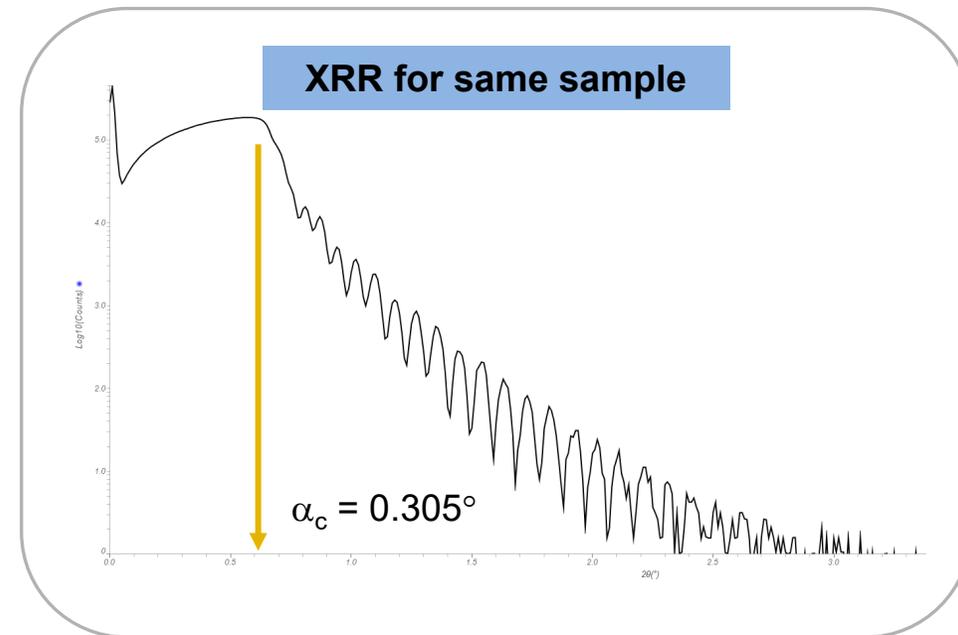
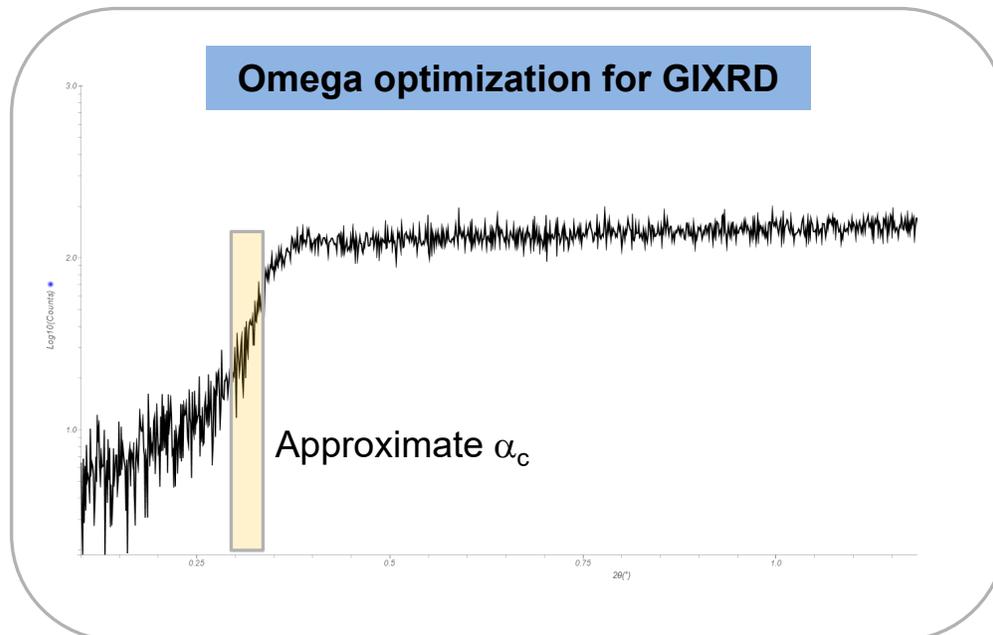


Lateral inhomogeneity cannot be successfully incorporated into XRR models



XRR can be used to:

- Determine the **critical angle (ω_c)** accurately
- Provide **evidence of film presence and thickness** regardless of crystallinity



Identified Issue	Causes and Steps
Alignment Steps Fail	Reposition or remount sample Check Omega scan for curvature effects (may need to reduce sample size) Check roughness with visual test or profilometry (may be too rough)
XRR scan intensity too low under 0.4° 2θ	If flexible substrate, remount (may need to glue entire sample back to substrate) If sample size is less than 20mm x 20mm, consider a larger sample Run alignment steps again Check Omega scan for curvature effects (may need to reduce sample size)
XRR scan has weak fringes	This is expected if density contrast is low Collect scan with narrower slits If film is thick (especially 400nm and greater), run using incident-side monochromator Lateral inhomogeneity may be the cause
XRR scan is without fringes	Collect scan with narrower slits If film is thick (especially 400nm and greater), run using incident-side monochromator Check that there is a film present Lateral inhomogeneity may be the cause

Appreciation and thanks to:



MEET THE ONYX EDXRF

HIGH-SPEED
ANALYSIS OF
MICRON-SCALE
FEATURES AND
DEVICES

GUEST SPEAKER:

Brad Lawrence
Product Marketing Manager,
XwinSys Onyx from Rigaku

July 23, 2020 11am PDT



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(Essential Businesses and Urgent Samples)

We are updating information on this website and some destinations maybe under construction. We appreciate your understanding and patience as we complete these improvements. Thank you.

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**No
Expedite
Fees**



**Data and
Insight**



**Competitive
Prices**



**Flexible
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Covalent Metrology is a modern materials characterization company staffed by world-class scientists and engineers



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The DATA PORTAL is used by Customers and Lab Partners for uploading and downloading data. It requires two-factor authentication and advanced password protection. Data Portal users have complete access through their home page on the portal to all Community content, and do not require a separate Community account.

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